

M/A-COM Products Released, 23 Jun 09

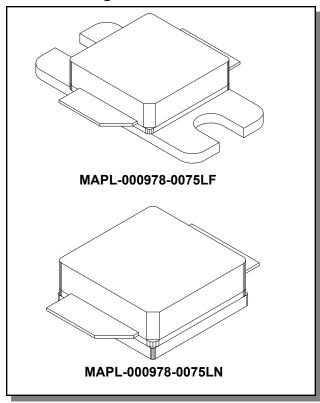
#### **Features**

- Gold LDMOS microwave power transistor
- Common source configuration
- Broadband Class AB operation
- RoHS Compliant
- Avionics applications specifically designed for Internal input and output impedance matching.
- Integrated ESD Protection
- **RoHS Compliant**

## Absolute Maximum Ratings at 25°C

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DSS}$	60	V
Gate-Source Voltage	$V_{GS}$	-0.7 to 15	V
Total Power Dissipation (T <sub>C</sub> = 25°C)	P <sub>TOT</sub>	350	W
Storage Temperature	T <sub>STG</sub>	-65 to +175	°C
Junction Temperature	$T_J$	200	°C

### **Product Image**



#### **Thermal Characteristics**

Parameter	Test Conditions	Symbol	Max	Units
Thermal Resistance, Junction to Case	$V_{DD} = 28V$ , $I_{DQ} = 250$ mA, Pout = 75W	R <sub>TH(JC)</sub>	0.5	°C/W

# **Typical RF Performance**

Freq.	Pin	Pout	Gain	ld-Pk	Eff	RL	VSWR-S	VSWR-T	P1	dB
(MHz)	(W)	(W)	(dB)	(A)	(%)	(dB)	(2:1)	(5:1)	Pout (W)	Gain (dB)
978	1.1	75	18.2	5.3	50	-16	S	Р	81	18.0

Typical RF performance measured in M/A-COM RF test fixture. Devices tested in common source Class-AB configuration as follows: Vdd=28V, Idg=250mA (pulsed), F=978MHz, Pulse=400us, Duty=1%.

<sup>•</sup> India Tel: +91.80.4155721 Visit www.macomtech.com for additional data sheets and product information.



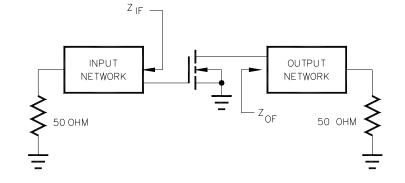
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Electrical Specifications:  $T_C = 25 \pm 5^{\circ}C$  (Room Ambient)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
DC CHARACTERISTICS						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 30mA$	BV <sub>DSS</sub>	60	-	-	V
Drain Leakage Current	V <sub>DS</sub> = 28V, V <sub>GS</sub> = 0V	I <sub>DSS</sub>	-	-	50	μΑ
Gate-Source Leakage Current	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0V	I <sub>GSS</sub>	-	-	2	μΑ
Gate Threshold Voltage	$V_{DS} = 10V$ , $I_D = 30mA$	V <sub>GS (th)</sub>	2	2.5	4	V
Forward Transconductance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1A	G <sub>M</sub>	1.5	-	-	S
DYNAMIC CHARACTERISTIC	DYNAMIC CHARACTERISTICS					
Input Capacitance	V <sub>DS</sub> = 28V, V <sub>GS</sub> = 0V, F = 1MHz (capacitance values without internal matching)	C <sub>iss</sub>	-	200	-	pF
Output Capacitance	$V_{DS} = 28V$ , $V_{GS} = 0V$ , $F = 1MHz$	C <sub>oss</sub>	-	83	-	pF
Reverse Transfer Capacitance	$V_{DS} = 28V$ , $V_{GS} = 0V$ , $F = 1MHz$	C <sub>rss</sub>	-	3.0	-	pF
RF FUNCTIONAL TESTS						
Power Gain	V <sub>DD</sub> = 28V, I <sub>DQ</sub> = 250mA, Pout = 75W	G <sub>P</sub>	16.5	18.2	-	dB
Drain Efficiency	$V_{DD} = 28V$ , $I_{DQ} = 250$ mA, Pout = 75W	$\eta_{\text{D}}$	45	50	-	%
Input Return Loss	V <sub>DD</sub> = 28V, I <sub>DQ</sub> = 250mA, Pout = 75W	RL	-	-16	-10	dB
1dB Compression Point	V <sub>DD</sub> = 28V, I <sub>DQ</sub> = 250mA	P1dB	-	81	-	W
Load Mismatch Stability	V <sub>DD</sub> = 28V, I <sub>DQ</sub> = 250mA, Pout = 75W	VSWR-S	-	-	2:1	-
Load Mismatch Tolerance	V <sub>DD</sub> = 28V, I <sub>DQ</sub> = 250mA, Pout = 75W	VSWR-T	-	-	5:1	-

# **Test Fixture Impedance**

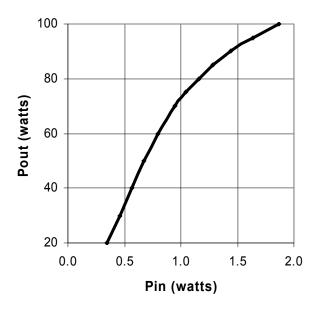
F (MHz)	Z <sub>IF</sub> (Ω)	Z <sub>OF</sub> (Ω)		
978	9.8 + j1.4	1.5 + j0.1		



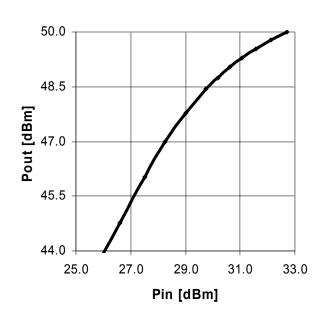


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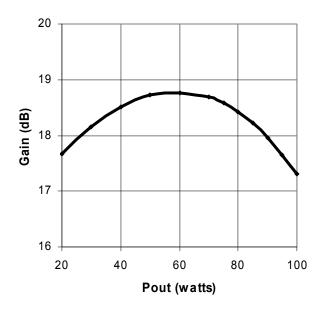
# **Output Power vs. Input Power**



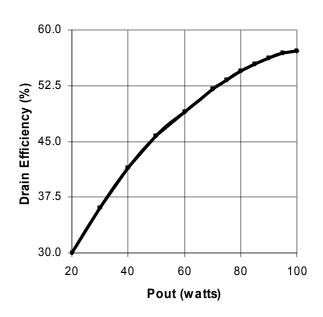
#### Output Power vs. Input Power [dBm]



### RF Power Gain vs. Output Power



# Drain Efficiency vs. Output Power



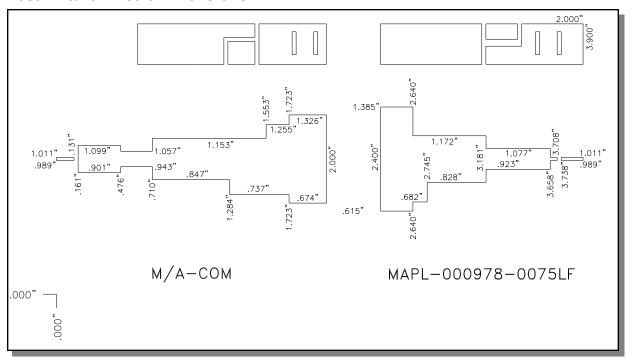
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Visit www.macomtech.com for additional data sheets and product information.

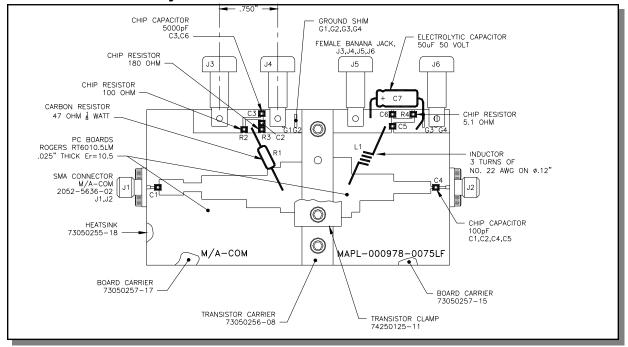


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#### **Test Fixture Circuit Dimensions**



### **Test Fixture Assembly**

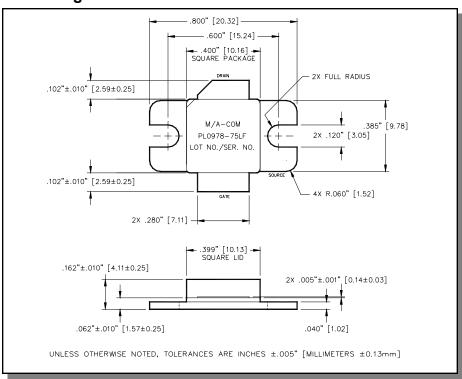


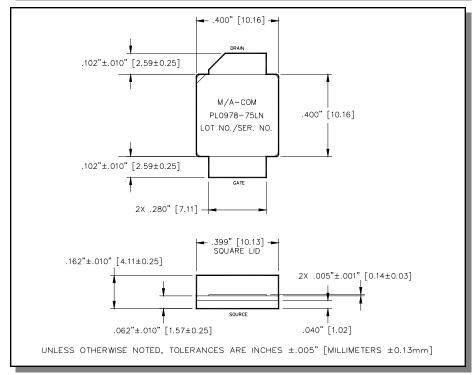
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# **Outline Drawings**





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